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# **DEK HORIZON 8 Platform**

**Technical Specification** 

Part No. 573069 - Issue 02 - August 2014

## **Technical Specifications**

### **DEK Horizon 8**

## Machine Standard Configuration

Standard Configuration	Specification
Machine Alignment Capability	>2 Cpk @ +/- 12.5μm, 6 Sigma *
Process Alignment Capability	>2 Cpk @ +/- 25μm, 6 Sigma *
Core Cycle Time	12 secs
Maximum Print Area	508mm (X) x 508mm (Y)
Printer Construction	One piece optimised welded frame
ISCAN <sup>TM</sup> Machine Control	Motion control using CAN BUS network
Operating System	Windows embedded XP
Operator Interface  Camera	Colour TFT touch screen display, keyboard and trackball with DEK Instinctiv <sup>TM</sup> software. Machine mountable on either left or right hand side.  HawkEye® 750 digital camera, using IEEE 1394 interface. Multi channel. LED
	lighting. FOV 11.3mm x 8.7mm. Inspection window 26mm <sup>2</sup>
Camera Positioning	Rotary motors and encoders with 4 micron resolution
Squeegee Pressure Mechanism	Software controlled, motorised with closed loop feedback
Adjustable Stencil Mount (ASM)	Frame variants – Fully adjustable to accommodate frame sizes in the range of 305mm to 736mm (12" to 29") by 38mm height Image position: centre/front/custom
Stencil Positioning	Manual with screen depth adjuster
Stencil Alignment	Motorised via actuators X, Y, and Theta
Under-Stencil Cleaning	Blue Under Stencil cleaner, fully programmable with wet/dry/vacuum wipe with external solvent tank
Vacuum Assist for Under-Stencil Cleaning	On board venturi vacuum unit
Squeegee	Clamped double trailing edge squeegee (1 set included)
Tooling Deviation Monitor	Verification of tooling setup via squeegee pressure feedback
Machine Interface	Upline and downline FMI included
Connectivity	RJ-45LAN (networking) and USB2 interface available
Tri Colour Beacon	Programmable with audible alarm
Temperature & Humidity Sensor	Monitoring of the process environment
Documentation	Hard copy manuals comprising: Operator, Installation, Electrical Drawings. On board technical manuals and tutorials supporting operator functions. CD containing manuals and tutorials.

<sup>\*</sup> DEK's machine accuracy and repeatability qualification is certified by 3rd party and undertaken using production environment process variables. Print Speeds, Print Pressures, Rising Table and Camera Movements are included in the process capability figure.



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## **Machine Standard Configuration**

Transport System	Specification
Туре	Single piece with 3mm round transport belts, front rail fixed
ESD Compatibility	Black transport belts and guides with surface resistivity of greater than $10^6$ ohms.
Width Adjustment	Programmable motorized rear rail
Transport Direction	Left to right
	Right to left
	Left to left
	Right to right
Substrate Handling Size (minimum)	50mm (X) x 40.5mm (Y)
Substrate Handling Size (maximum)	510mm (X) x 508.5mm (Y)
Substrate Thickness	0.2mm to 6mm
Substrate Weight (maximum)	1kg
Substrate Warpage	Up to 7mm including substrate thickness
Substrate Fixture	Patented over the top clamps
Substrate Handling Features	Soft rail lift / land
Ç	Board clamp regulator
Substrate Underside Clearance	Programmable 3mm to 42mm

Process Parameters	Specification
Print Pressure	0kg to 20kg
Print Speed	2mm/sec to 300mm/sec
Print Gap	0mm to 6mm
Substrate Separation	Speed: 0.1mm/sec to 20mm/sec
	Distance: 0mm to 20mm
Print Modes	Print / Print
	Print / Flood
	Flood / Print
	Adhesive
Paste Knead	Programmable: number; period; on demand

Vision	Specification
Vision System	Cognex
Fiducial Recognition	Automatic fiducial teach and find incorporating 0.1mm fiducial capture
Fiducials	2 or 3
Fiducial Types	Synthetic fiducial library or unique pattern recognition
Fiducial Size	0.1mm to 3mm
Fiducial Locations	Anywhere on substrate
Fiducial Error Recovery	Auto lighting adjustment Auto fiducial search
Camera Lighting	Software controlled programmable LED lighting



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On a ration Figure 2 and	Consideration
Operating Environment	Specification
Temperature	10° to 35° C (50° to 95° F)
Humidity	30% to 70% relative humidity (non-condensing)
Services	Specification
Voltage	100 Volts to 240 Volts +/- 10%. Single phase 50/60Hz
Maximum Current at 115V	20 Amps with vacuum pump
	6 Amps without vacuum pump
Maximum Current at 230V	10 Amps with vacuum pump
	3 Amps without vacuum pump
Over Current Protection	An external circuit breaker ≤ 25 Amps is required to be fitted in line with the
	machine supply
Air Supply	To ISO 8573.1 Standard Quality Class 2.3.3
	Pressure 5 bar to 8 bar
	General usage 5 litres/minute at 5 bar to 8 bar
	Maximum usage 226 litres/minute at 6 bar
Shipping Information	Specification
Approximate Weight	790kg boxed (dependent upon configured options selected with machine)
	630kg unboxed (dependent upon configured options selected with machine)
Approximate Dimensions	2060mm x 1500mm x 1570mm (81.1" x 59" x 61.8")
Certification	Specification
CE	98/37/EC
	89/336/EEC
	73/23/EEC
	Subsequent amendments
Acoustic Noise Level	Less than 70dB 2003/1/EC



### **DEK Horizon 8**

## **Machine Productivity Options**

Process	Specification
Print Method	Paste roll height monitor
Stencil Frame	VectorGuard®
Stencil Positioning	Semi automatic loading incorporating squeegee drip tray*

<sup>\*</sup> Need to remove drip tray when using ProActiv

Transport	Specification
Substrate Support	Vacuum tooling capability
	Vacuum tooling sensor
	Vacuum cups
	Grid-Lok® Tooling
Substrate Fixture	Foil-less clamps
	250mm over the top clamps

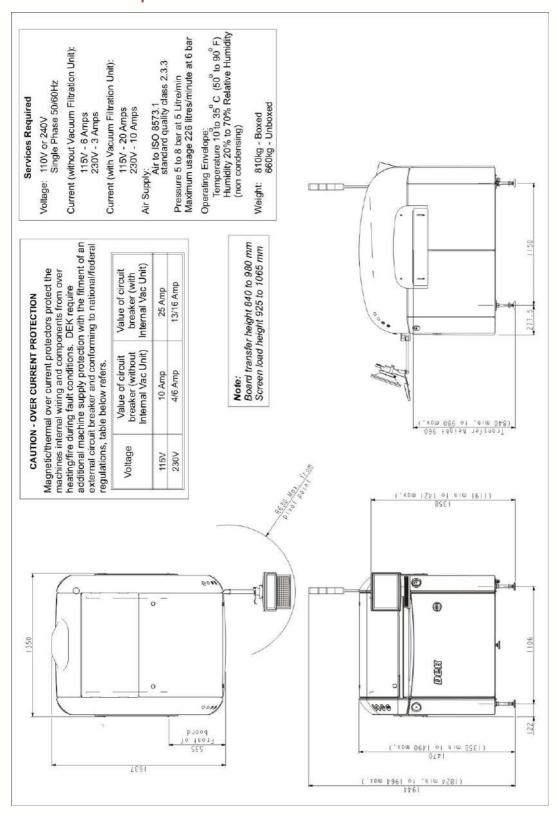
Vision	Specification
HawkEye®750 Functionality	Enabled

Software & Communications	Specification
Statistical Process Control	On board, reported via operator interface (QC-CALC)
Other	Specification
Cycle Time Improvement	12 seconds to 10 seconds Left hand side



#### **DEK Horizon 8**

### **Machine Footprint**





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